

200W, 24V ESD Protection Array

FEATURES

- Small package for use in portable electronics
- Meet IEC61000-4-2(ESD) $\pm 30\text{kV}$ (air) , $\pm 30\text{kV}$ (contact)
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High Speed Line: USB 2.0 / VGA/ DVI /SDI /HDMI
- Touch Panel
- Battery Management System
- POE PD

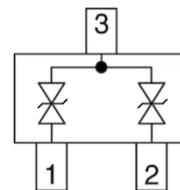
MECHANICAL DATA

- Case: SOT-23
- Molding compound meets UL 94 V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Weight: 8.70mg (approximately)
- Marking code on the device: W3

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
P_{PPM}	200	W
I_{PP}	3	A
V_{WM}	24	V
V_C at $I_{PP} = 3\text{ A}$	70	V
Package	SOT-23	



SOT-23



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	TESD24VS2BT	UNIT
Rated random recurring peak Impulse power dissipation (tp = 8/20 μs waveform)	P_{PPM}	200	W
Peak impulse current (tp = 8/20 μs waveform)	I_{PP}	3	A
ESD per IEC 61000-4-2 (Air)	V_{ESD}	± 30	kV
ESD per IEC 61000-4-2 (Contact)		± 30	kV
Junction temperature range	T_J	-55 to +150	$^\circ\text{C}$
Storage temperature range	T_{STG}	-55 to +150	$^\circ\text{C}$

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Reverse breakdown voltage ⁽¹⁾	$I_R = 5\text{mA}$	$V_{(BR)}$	25.4	-	-	V
Rated working standoff voltage		V_{WM}	-	-	24	V
Reverse current ⁽¹⁾	$V_R = 24\text{V}$	I_R	-	-	50	nA
Clamping voltage ⁽²⁾	$I_{PP} = 1\text{A}$	V_C	-	-	40	V
Clamping voltage ⁽²⁾	$I_{PP} = 3\text{A}$	V_C	-	-	70	V
Junction capacitance	1MHz, $V_R = 0\text{V}$	C_J	-	11	-	pF

Notes:

1. Pulse test with $PW = 30\text{ms}$
2. $t_p = 8/20\mu\text{s}$ waveform

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
TESD24VS2BT RFG	SOT-23	3K / 7" Reel

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 8/20 μs pulse waveform according to IEC 61000-4-5

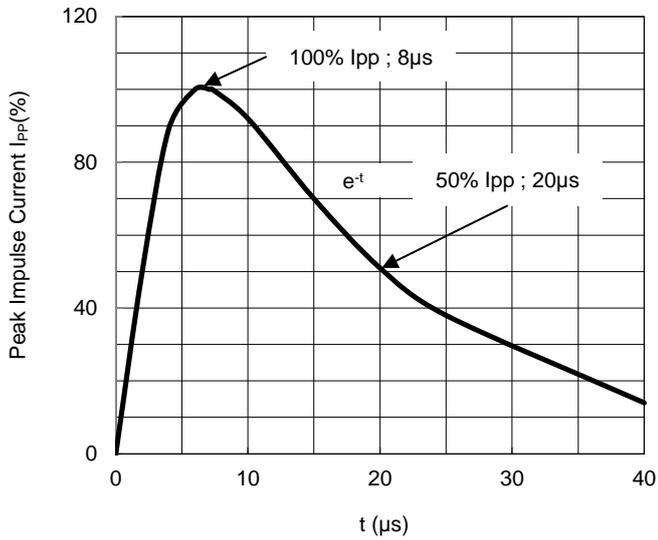


Fig.2 ESD pulse waveform according to IEC 61000-4-2

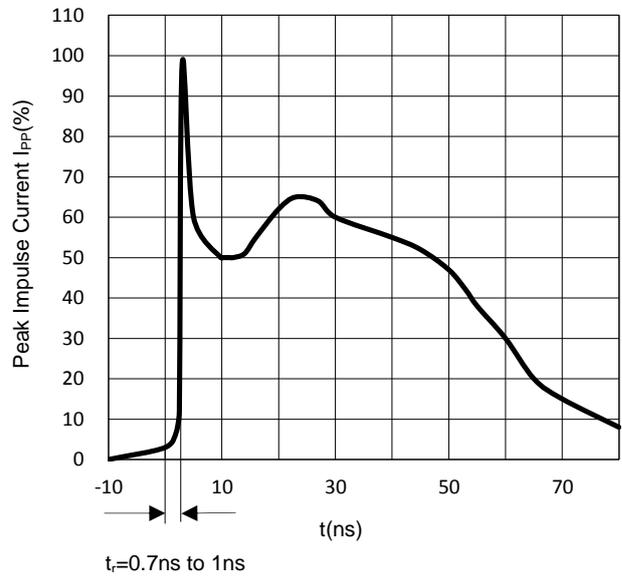
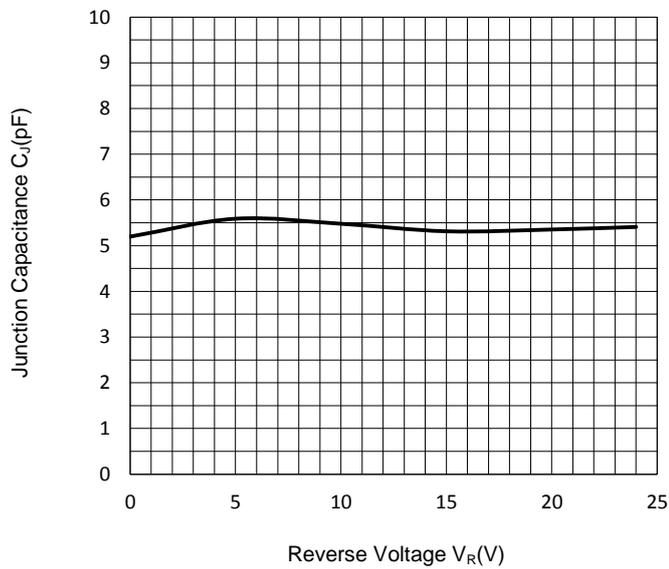
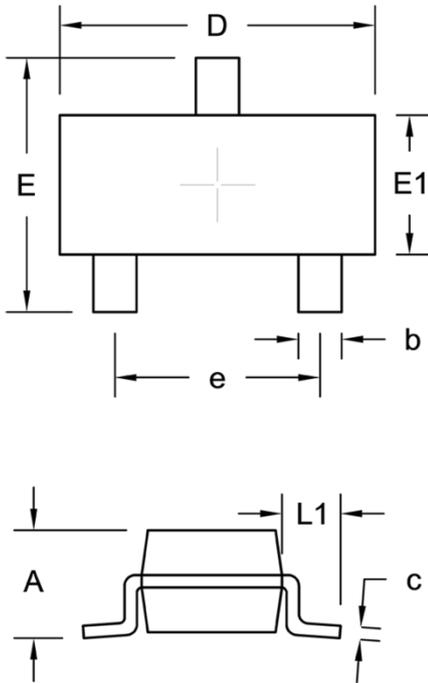


Fig.3 Typical Junction Capacitance



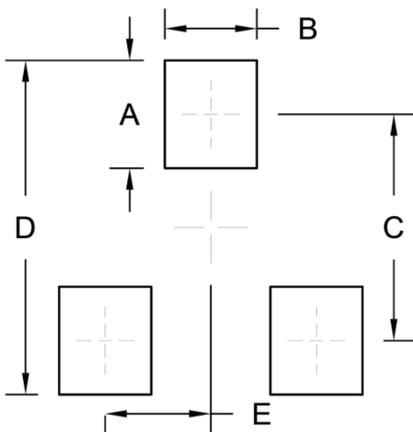
PACKAGE OUTLINE DIMENSIONS

SOT-23



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.89	1.12	0.035	0.044
b	0.30	0.50	0.012	0.020
c	0.08	0.20	0.003	0.008
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E1	1.20	1.40	0.047	0.055
e	1.90 BSC		0.075 BSC	
L1	0.54 REF.		0.021 REF.	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.00	0.039
B	0.85	0.033
C	2.10	0.083
D	3.10	0.122
E	0.98	0.039

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.